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To the Honorable Commissioner of Patent:

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red original documents or copy thereof.

1. Name of conveying party(ies)

Veselin BRANKOVIC, Dragan KRUPZEVIC, Masayoshi ABE, Tino KONSCHAK, Thomas DÖLLE

Additional name(s) of conveying party(ies) attached?
 Yes No

2. Name and address of receiving party(ies)

Name: SONY International (Europe) GmbH
Hugo-Eckener-Strasse 20
D-50829 Köln-Ossendorf
GERMANY

and

Sony Corporation
7-35 Kitashinagawa 6-Chome, Shinagawa-Ku,
Tokyo 141, Japan

Additional name(s) & address(es) attached? Yes No

jc714 U.S. PTO
09/578755
05/25/00

3. Nature of conveyance:

- Assignment
- Security Agreement
- Merger
- Change of Name
- Other

Execution Date: January 18, January 18, February 2, January 18 and January 18, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: January 18, January 18, February 2, January 18 and January 18, 2000

A. Patent Application No.(s) _____ filed _____

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WILLIAM S. FROMMER
Internal Address: FROMMER LAWRENCE & HAUG LLP
Street Address: 745 FIFTH AVENUE
City: NEW YORK State: N.Y. Zip: 10151

6. Total number of applications and patents involved

1

7. Total fee (37 CFR 3.41) \$ 40.00

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William S. Frommer
Name of Person Signing

Signature

May 25, 2000
Date

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ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

Down Converter and Demodulator using a Three port junction

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY INTERNATIONAL (EUROPE) GmbH, a German corporation, with offices at Hugo-Eckener-Strasse 20, D-50829 Köln-Ossendorf, GERMANY and SONY CORPORATION, a Japanese corporation, with offices at 6-7-35 Kitashinagawa, Shinagawa-ku, Tokyo 141 JAPAN (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: _____, Filing Date: _____

This assignment executed on the dates indicated below.

Veselin BRANKOVIC

Name of first or sole inventor

Execution date of U.S. Patent Application

Fellbach, Germany

Residence of first or sole inventor

Veselin Brankovic

Signature of first or sole inventor

18.1.2000

Date of this assignment

Dragan KRUPZEVIC

Name of second inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of second inventor

Dragan Krupzevic

Signature of second inventor

18.1.2000

Date of this assignment

Masayoshi ABE

Name of third inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of third inventor

Masayoshi Abe

Signature of third inventor

02.02.2000

Date of this assignment

Tino KONSCHAK

Name of fourth inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of fourth inventor



Signature of fourth inventor

18.01.2000

Date of this assignment

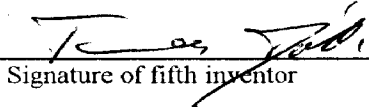
Thomas DÖLLE

Name of fifth inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of fifth inventor



Signature of fifth inventor

18.01.2000

Date of this assignment